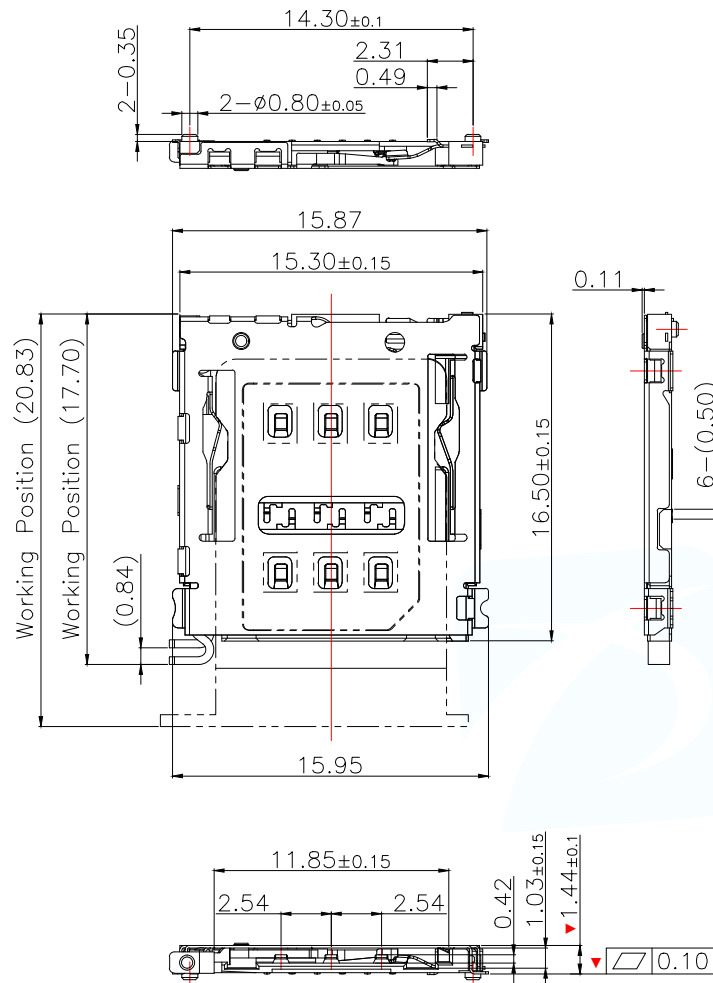
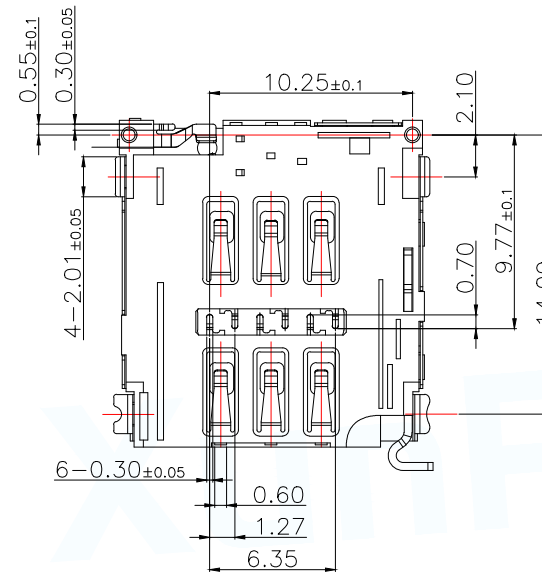




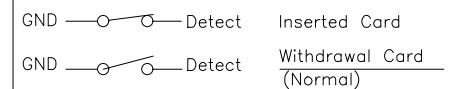
PIN 1#	C1: VCC
PIN 2#	C5: Grand
PIN 3#	C2: Reset
PIN 4#	C6: VPP
PIN 5#	C3: Clock
PIN 6#	C7: I/O



NOTE:

⚠ Material & Finish See Table;

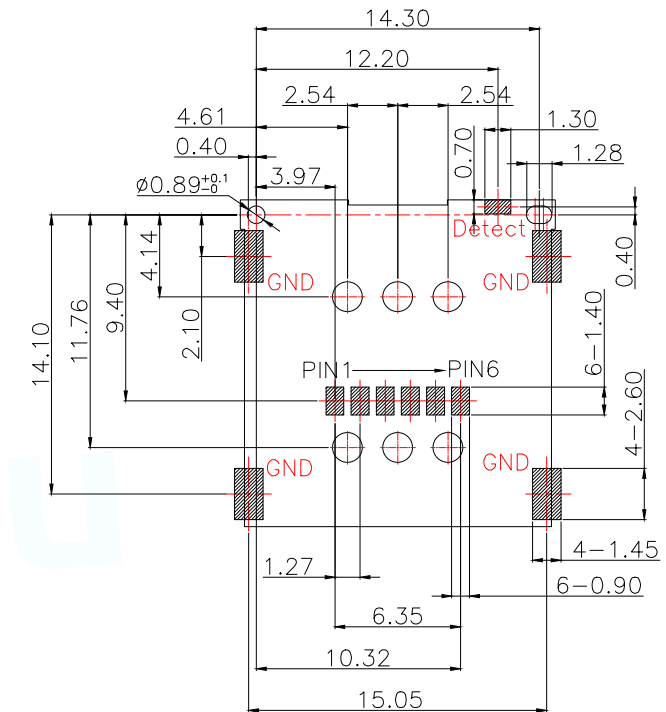
2. Circuit Diagram For Switch



3. Characteristic:

- 3-1.Current Rating :1A max.
- 3-2.Contact Resistance:50mOhms max
- 3-3.Insulation Resistance:100MOhms min./500VDC
- 3-4.Dielectric Withstanding Voltage:500VAC/1minute
- 3-5.Mating Force: 10N Max, Withdrawal Force: 1N Min.;
- 3-6.Durability: 1500 Cycles
- 3-7.Operating Temperature:-25°C to+85°C

4. Critical Dimensions Marked "▼" Should Check By QC.



6	Shell	Stainless Steel	Nickel Under Plated Overall.
5	Lever	Stainless Steel	/
4	Cam	Stainless Steel	/
3	Housing	Thermoplastics	Black,UL94V-0
2	Detect	Copper Alloy	Gold Flash on Solder Tails and Contact Area; Nickel Under Plated Overall.
1	Terminal	Copper Alloy	Gold Flash on Solder Tails and Contact Area; Nickel Under Plated Overall.
Item	Part Name	Material	Description

MANUFACTURE DWG



东莞市讯普电子科技有限公司
DongGuan XunPu Electronics Co.,Ltd

UNLESS OTHERWISE
SPECIFIED TOLERANCES

TITLE:NANO SIM CARD H1.5
6pin 带检测PIN

DECIMALS: ANGLES:

X.:±0.50 X':±2°

X.X:±0.20 X.X':±1°

X.XX:±0.10

CUSTOMER COPY

PAR	SMN-328-ACP7
DWN	Lucas
CHKD	Ethan
APVD	Jacob
SCALE:1:1	UNIT:MM
SIZE:A4	SHEET:1F1
REV:A	

使用方向(Using Direction)

包裝方向(Packaging Direction)



1,每盘包装1000PCS产品.

包装要求如图示(二)

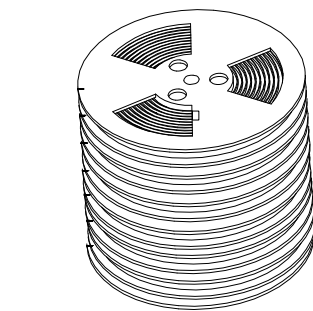
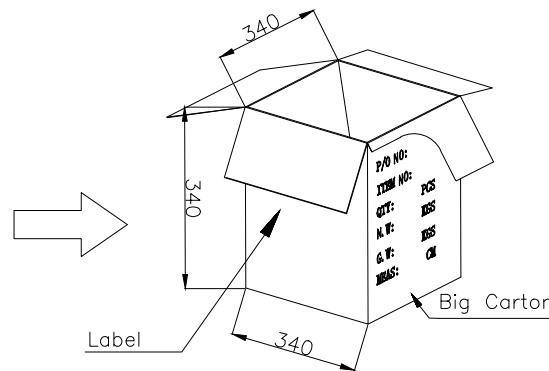
2,每箱包装数量8000PCS.纸箱外则以胶带封口成"工"字型.

3,上載帶剥离不速度:300mm/minutes.

4,卷带封合力小于100G.

5, 載帶用透明料料 料厚0.35mm.

图示(二)圆盘包装


$$1000\text{pcs} \times 8 = 8000\text{pcs}$$


MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd			
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE:NANO SIM CARD H1.5 6pin 零检测PIN		
			PAR	SMN-328-ACP7	
DECIMALS:	ANGLES:		DWN	Lucas	
X.:±0.50	X':±2°		CHKD	Ethan	
X.X:±0.20	X.X':±1°		APVD	Jacob	
X.XX:±0.10		CUSTOMER COPY	SCALE1:1	UNIT:MM 	
			SIZE:A4	SHEET:1F1	REV:A